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1. Name of conveying party(ies):

Shigeo KITAKA (May 14, 2007)
Masatoshi NARA (May 17, 2007)
Keiji TSUNETOMO (May 15, 2007)

6-12-07

2. Name and address of receiving party(ies):

Nippon Sheet Glass Company, Limited
5-27, Mita 3-chome
Minato-ku, Tokyo 108-6321
Japan

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
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11/792904

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

06/14/2007 MKAYPAGH 00000115 11792904

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Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Douglas P. Mueller
Address: Hamre, Schumann, Mueller & Larson P.C.
P. O. Box 2902
Minneapolis, MN 55402-0902

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- ☒ Enclosed
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PATENT TRADEMARK OFFICE

PATENT
REEL: 019459 FRAME: 0800

Docket No.

ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. Shigeo KITAKA residing at c/o Nippon Sheet Glass Company, Limited, 5-27, Mita 3-chome, Minato-ku, Tokyo, 108-6321 Japan and a citizen of Japan
2. Masatoshi NARA residing at c/o Nippon Sheet Glass Company, Limited, 5-27, Mita 3-chome, Minato-ku, Tokyo, 108-6321 Japan and a citizen of Japan
3. Keiji TSUNETOMO residing at c/o Nippon Sheet Glass Company, Limited, 5-27, Mita 3-chome, Minato-ku, Tokyo, 108-6321 Japan and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on _____, entitled WAVEGUIDE ELEMENT, METHOD FOR PRODUCING THE WAVEGUIDE ELEMENT, AND OPTICAL SENSOR, and which has been given application serial number _____;

and

WHEREAS Nippon Sheet Glass Company, Limited (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at 5-27, Mita 3-chome, Minato-ku, Tokyo, 108-6321 Japan wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the

said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Shigeo Kataka
Signature

May 14, 2007
Date

Masatoshi Nawa
Signature

May 17, 2007
Date

Heiji Tsumetomo
Signature

May 15, 2007
Date